-30V,-55A, 8.9mΩ P-channel Power Trench MOSFET

JMTK100P03A

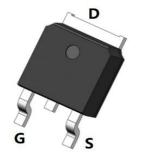
Features

- $\bullet \;\;$ Excellent $R_{\text{DS(ON)}}$ and Low Gate Charge
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant
- Applications
- Load Switch
- PWM Application
- Power Management

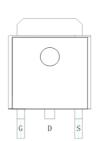
Product Summary

Parameters	Value	Unit
V_{DSS}	-30	٧
$V_{GS(th)_Typ}$	-1.6	٧
I _D (@V _{GS} =-10V)	-55	Α
$R_{DS(ON)_Typ}(@V_{GS}=-10V$	6.1	mΩ
$R_{DS(ON)_Typ}(@V_{GS}=-4.5V)$	8.9	mΩ

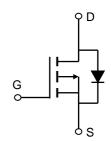








Pin Assignment



Schematic Diagram

Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMTK100P03A	JMTK100P03A	3	Tape&Reel	TO-252-3L	2500	25000

Absolute Maximum Ratings (@ T_C = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{DS}	Drain-to-Source Voltage		-30	V
V_{GS}	Gate-to-Source Voltage		±20	V
I-	Continuous Drain Current	$T_C = 25^{\circ}C$	-55	^
I _D	Continuous Drain Current	$T_C = 100$ °C	-35	- A
I _{DM}	Pulsed Drain Current (1)		Refer to Fig.4	Α
E _{AS}	Single Pulsed Avalanche Energ	y ⁽²⁾	206	mJ
P_{D}	Power Dissipation	$T_C = 25^{\circ}C$	43	W
' D	Fowei Dissipation	$T_C = 100$ °C	17	T vv
T_{J}, T_{STG}	Junction & Storage Temperature F	Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽³⁾	41	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.9	C/VV



Electrical Characteristics (T_J = 25°C unless otherwise specified)

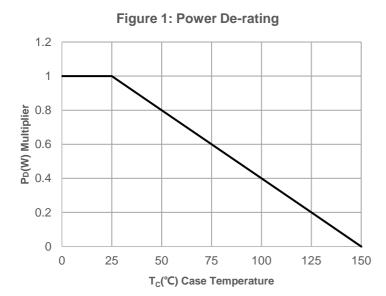
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	nracteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -30V, V_{GS} = 0V$	-	-	-1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics			•	•	•
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.1	-1.6	-2.5	V
D	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = -10V, I_D = -30A$	-	6.1	10.0	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance	$V_{GS} = -4.5V, I_D = -20A$	-	8.9	16.0	mΩ
Dynami	c Characteristics					
R_{g}	Gate Resistance	f = 1MHz	-	5.6	-	Ω
C _{iss}	Input Capacitance	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	2489	3485	4705	pF
C _{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = -15V,$ $f = 1MHz$	283	397	536	pF
C_{rss}	Reverse Transfer Capacitance	1 - 11/11/2	240	336	454	pF
Qg	Total Gate Charge	V 0. 40V	44	62	83	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to -10V}$ $V_{DS} = -15V, I_D = -20A$	7	10	13	nC
Q_{gd}	Gate Drain("Miller") Charge		9	12	16	nC
Switchi	ng Characteristics	T		Г	ı	ı
t _{d(on)}	Turn-On DelayTime	_	-	16	-	ns
t _r	Turn-On Rise Time	$V_{GS} = -10V, V_{DD} = -15V$	-	62	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_D = -20A$, $R_{GEN} = 3\Omega$	-	55	-	ns
t_f	Turn-Off Fall Time		-	70	-	ns
Body D	iode Characteristics			T	•	T
I _S	Maximum Continuous Body Diode Forward	Current	-	-	-55	А
I _{SM}	Maximum Pulsed Body Diode Forward Cur	rent	-	-	-221	Α
V_{SD}	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = -30A$	-		1.2	V
trr	Body Diode Reverse Recovery Time	I _F = -15A, di/dt = 100A/us	15	22	29	ns
Qrr	Body Diode Reverse Recovery Charge	$\prod_{i \in \{1, 2, 3, 3, 4, 4, 4, 4, 4, 4, 4, 4, 4, 4, 4, 4, 4,$	-	11.5	-	nC

Notes:

- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
- $2.\;E_{AS}\;condition:\;Starting\;T_{J}=25C,\;V_{DD}=-15V,\;V_{G}=-10V,\;R_{G}=25ohm,\;L=0.5mH,\;I_{AS}=-24.08A,\;V_{DD}=0V\;during\;time\;in\;avalanche.$
- 3. $R_{\theta JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB.
- 4. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.



Typical Performance Characteristics



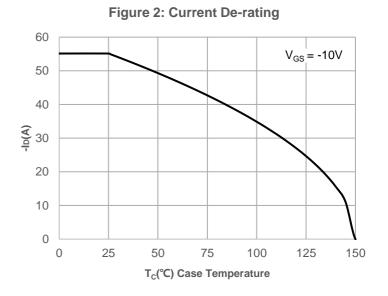
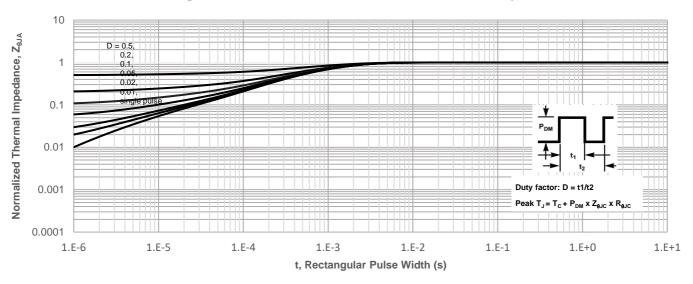
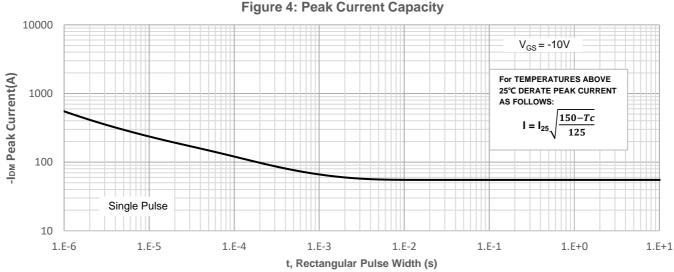


Figure 3: Normalized Maximum Transient Thermal Impedance







Typical Performance Characteristics

Figure 5: Output Characteristics

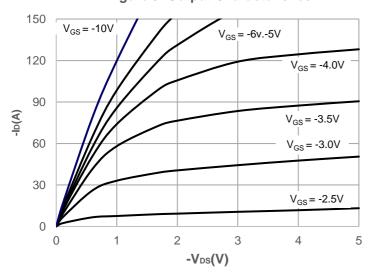


Figure 6: Typical Transfer Characteristics

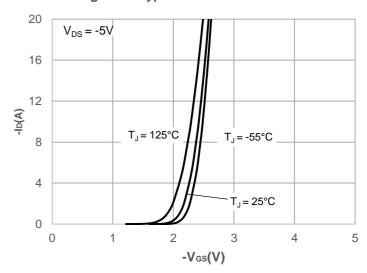


Figure 7: On-resistance vs. Drain Current

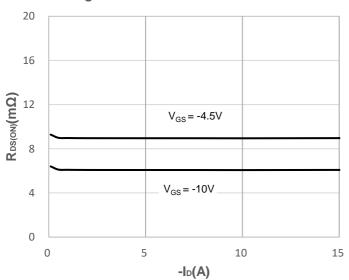


Figure 8: Body Diode Characteristics

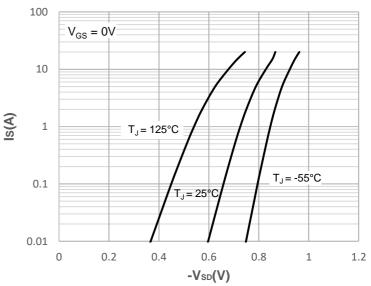


Figure 9: Gate Charge Characteristics

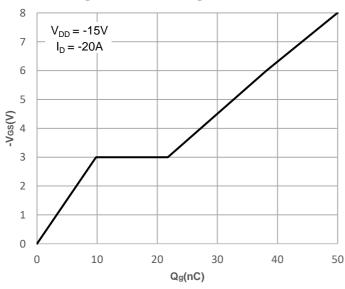
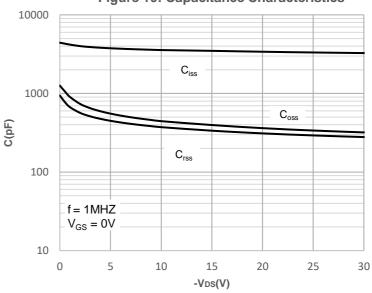


Figure 10: Capacitance Characteristics





Typical Performance Characteristics

Figure 11: Normalized Breakdown voltage vs. Junction Temperature

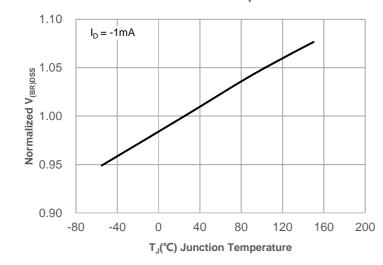


Figure 13: Normalized Threshold Voltage vs. Junction Temperature

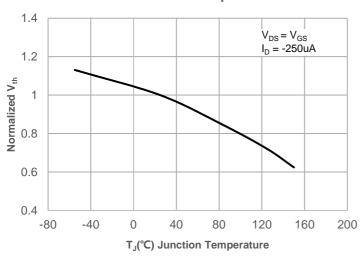


Figure 15: Maximum Safe Operating Area

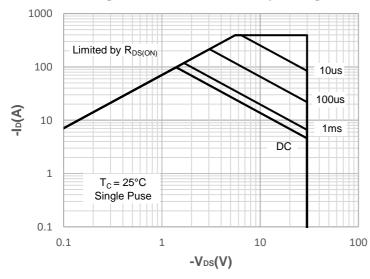
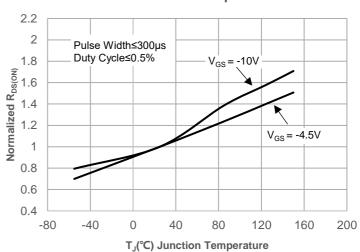
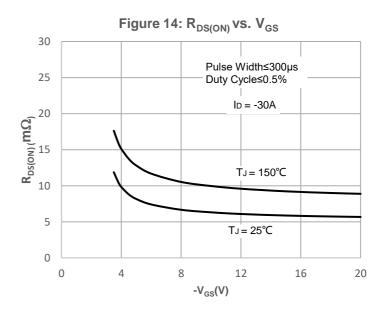


Figure 12: Normalized on Resistance vs. Junction Temperature







Test Circuit

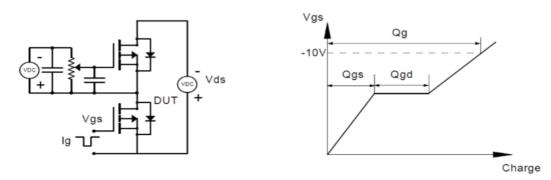


Figure 1: Gate Charge Test Circuit & Waveform

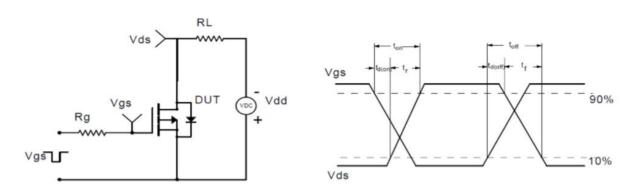


Figure 2: Resistive Switching Test Circuit & Waveform

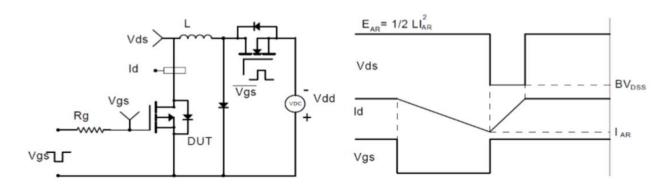


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

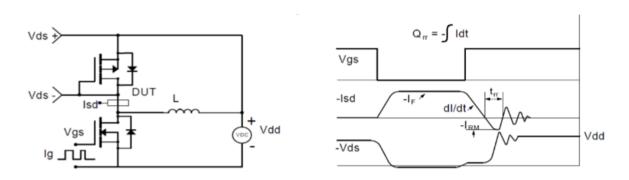
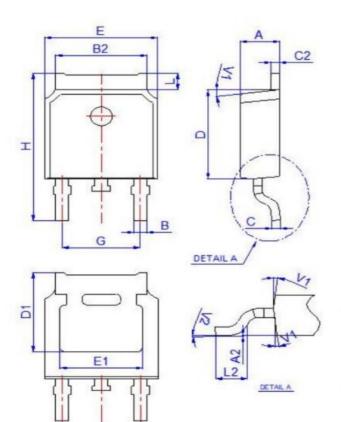


Figure 4: Diode Recovery Test Circuit & Waveform

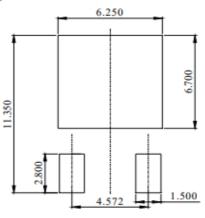


Package Mechanical Data(TO-252-3L)



	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	2.10		2.50	0.083		0.098	
A2	0		0.10	0		0.004	
В	0.66		0.86	0.026		0.034	
B2	5.18		5.48	0.202		0.216	
C	0.40		0.60	0.016		0.024	
C2	0.44		0.58	0.017		0.023	
D	5.90		6.30	0.232		0.248	
D1		5.30REF	=	0.209REF			
E	6.40		6.80	0.252		0.268	
E1	4.63			0.182			
G	4.47		4.67	0.176		0.184	
Н	9.50		10.70	0.374		0.421	
L	1.09		1.21	0.043		0.048	
L2	1.35		1.65	0.053		0.065	
V1		7°			7°		
V2	0°		6°	0°	V	6°	

Recommended Soldering Footprint



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